		2		3			4		
TOP LAYER		TABLE I PLATED THROUGH-HOLE REQUIF							
DESCRIPTION		DRILLED HOLE DIAMETER		COPPER THICKNESS					C THI
TIN-LEAD				0.025 - 0.050	0.005 -	0.0 5	-	-	
IMMERSION TIN									
				0.025 - 0.050			-	-	
GOLD		0.81-0.86 (0.85 DRI		0.025 - 0.050			0.003 -	0.007	FLASH UF
NOTES									2 .
\frown		G: HIGH TEMPERATURE		OPLASTIC, BLACK				A	DJACENT PO NOTE
	CONTAC			R ALLOY					
 a) CONTACT PLATING (LEAD FREE): PRESS-FIT TAIL MATTE TIN OVER NICKEL. b) CONTACT PLATING (LEADED): 									CONNE
SE	PARABLE	INTERFACE:0.76 um M	IN GXT	OVER NICKEL					≜
3. PRO	PRODUCT SPECIFICATION: GS-12-220								
4. APP	LICATIO	N SPECIFICATION: GS	-20-02	3					
5 PRO	DUCT MA	RKING (PRODUCT NUMBE	r & da	TE CODE) ON HOU	SING IN ARE	A SHOW	/N.		
6) MIN	IMUM NO	MINAL PCB THICKNESS:	l.6m	m					
						ES.			
	PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN FCI SPECIFICATION GS-22-008. (18.85)								(8.85)
9. PAC	KAGING	MEETS FCI SPECIFICAT	ION GS	- 4 - 920.					
PEA	Κ ΤΕΜΡΕ	RATURE FOR 60 SECOND			FRA-RED,				9
(I) COP NO	PER PLA More th	TING THICKNESS IN CE AN 0.003 LESS THAN O	NTER O THER A	F VIA-HOLE CAN REAS.	BE				
VIE	W, OR N	ote which has been m			ENT				
								В	Ţ
	DESCRIPTION TIN-LEAD IMMERSION TI IMMERSION SILV COPPER (SEE NOTE GOLD NOTES: (1.) CON (2.) a) b) SE 3. PRO (3.) PRO (6) MIN (7) REF PCB (8) PRO (8) PRO (10) HOU PEA OR (11) COP	DESCRIPTION TIN-LEAD IMMERSION TIN IMMERSION SILVER COPPER (SEE NOTE II) GOLD NOTES: (1) CONNECTOR I HOUSING CONTACT (2) a) CONTACT b) CONTACT b) CONTACT SEPARABLE 3. PRODUCT SPI 4. APPLICATION (5) PRODUCT MAN (6) MINIMUM NON (7) REFER TO CL PCB LAYOUT (8) PRODUCT MEN REGULATION 9. PACKAGING I (10) HOUSING CON PEAK TEMPE OR VAPOR PLA NO MORE THAN 12. A EN SYMBON VIEW, OR NO	DESCRIPTION DRILLED HOLE DIAMETER TIN-LEAD 0.81-0.86 (0.85 DRI IMMERSION TIN 0.81-0.86 (0.85 DRI IMMERSION SILVER 0.81-0.86 (0.85 DRI COPPER (SEE NOTE II) 0.81-0.86 (0.85 DRI GOLD 0.81-0.86 (0.85 DRI BOLD 0.81-0.86 (0.85 DRI GOLD 0.81-0.86 (0.85 DRI MINIMAC PERSS-FIT TAIL SPRODUCT SPECIFICATION: GS-12- GOLD MINIMUM NOMINAL PCB THICKNESS: GOLD MINIMU	DESCRIPTION DRILLED HOLE DIAMETER TIN-LEAD 0.81-0.86 (0.85 DRILL) IMMERSION TIN 0.81-0.86 (0.85 DRILL) IMMERSION SILVER 0.81-0.86 (0.85 DRILL) COPPER (SEE NOTE II) 0.81-0.86 (0.85 DRILL) COLD 0.81-0.86 (0.85 DRILL) CONTACT PLATING LEADEDY PRESS-FIT TAIL MATTE TIN LOONTACT PLATING (LEADED): PRESS-FIT TAIL: MATTE TIN b) CONTACT PLATING (LEADED): PRESS-FIT TAIL: TIN-LEAD A SEPARABLE INTERFACE:0.76 um MIN GXT 3. PRODUCT SPECIFICATION: GS-20-02 S PRODUCT MARKING (PRODUCT NUMBER & DA G MINIMUM NOMINAL PCB THICKNESS: I.6m R REFER TO CUSTOMER DRA	DESCRIPTION DRILLED HOLE COPPER TIN-LEAD 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 IMMERSION TIN 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 IMMERSION SILVER 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 COPPER (SEE NOTE II) 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 COPPER (SEE NOTE II) 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 GOLD 0.0185011010 DRESTER	DESCRIPTION DRILLED HOLE COPPER TIN-LE TIN-LEAD 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 0.005 - 0.050 IMMERSION TIN 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 IMMERSION TIN 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 GOLD 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 GO	DESCRIPTION DRILLED HOLE COPPER TIN-LEAD TIN-LEAD 0.81-C.88 (C.85 DRILL) 0.025 - 0.030 0.000 - 0.015 IMMIRSION TIN 0.81-C.88 (C.85 DRILL) 0.025 - 0.030 IMMIRSION SILVER 0.81-C.88 (C.85 DRILL) 0.025 - 0.030 GOUDE (SLE NOIL TI) 0.81-C.88 (C.85 DRILL) 0.025 - 0.030 GOLB 0.81-C.88 (C.85 DRILL) 0.025 - 0.050 GOLB 0.81-C.88 (C.85 DRILL) 0.025 - 0.050 GOLD 0.81-C.88 (C.85 DRILL) 0.025 - 0.050 GOLD 0.81-C.88 (C.85 DRILL) 0.025 - 0.050 GOLD 0.81-C.88 (C.85 DRILL) 0.025 - 0.050 GOLB 0.81-C.88 (C.85 DRILL) 0.025 - 0.050 GOLD 0.81-C.88 (C.85 DRILL) 0.025 PRESTICE 0.050	DESCRIPTION DESCRIPTION COPPER TIN-LEAD Diameter TIN-LEAD 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 0.000 - 0.015 - IMMERSION SILVEN 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 - - - IMMERSION SILVEN 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 - - - IMMERSION SILVEN 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 - - - COMPERTISE 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 - - - - - GOUD 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 - - 0.003 - GOUD 0.81-0.86 (0.85 DRILL) 0.025 - 0.050 - - 0.003 - CONTACT P.ALING (LEAD FREES) DL 924 - 0 COMPLIANT 0.0050 - 0.003 - CONTACT P.ATING (LEAD FREES) PRESS-FIT TAIL: MATTE TIN OVER NICKEL - 0.003 - SCONTACT P.ATING (LEAD FREES) PRESS-FIT TAIL: MATTE TIN OVER NICKEL - 0.003 - - SCONTACT P.ATING (LEAD FREES) <t< td=""><td>ID2-14YFB PLATED PLAT</td></t<>	ID2-14YFB PLATED PLAT

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